## EXPEDITED PROCEDURE - EXAMINING GROUP 3729

S/N 10/815,464

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

PATENT

Applicant: Todd B Myers et al. Examiner: Thiem Phan Serial No.: 10/815,464 Group Art Unit: 3729

Filed: March 31, 2004 Docket No.: 884.B60US1

Title: METHOD OF EMBEDDING PASSIVE COMPONENT WITHIN VIA
Assignee: Intel Corporation Customer Number: 21186

## AMENDMENT & RESPONSE UNDER 37 C.F.R. 1.116

Mail Stop AF Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

In response to the Final Office Action mailed <u>August 1, 2006</u>, please amend the application as follows: